imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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IGBT - Field Stop II

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- These are Pb–Free Devices

Typical Applications

- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	80 40	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	200	A
Gate-emitter voltage Transient gate-emitter voltage ($T_{pulse} = 5 \ \mu s$, D < 0.10)	V_{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	535 267	W
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, T_J \leq 150°C	T _{SC}	10	μs
Operating junction temperature range	ТJ	–55 to +175	°C
Storage temperature range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

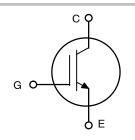
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

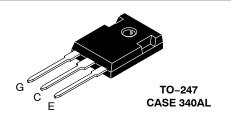


ON Semiconductor®

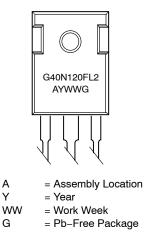
http://onsemi.com

40 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 1.10 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTG40N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.28	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC					
V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	1200	_	-	V
V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}		2.00 2.40	2.40 _	V
$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 500 \mu\text{A}$ $V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 500 \mu\text{A} \qquad V_{(BR)CES}$ $V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A} \qquad V_{CEsat}$ $V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	$\begin{array}{c c} V_{GE} = 0 \ V, \ I_C = 500 \ \mu A \\ V_{(BR)CES} \\ V_{GE} = 15 \ V, \ I_C = 40 \ A \\ V_{GE} = 15 \ V, \ I_C = 40 \ A, \ T_J = 175^{\circ}C \end{array} \begin{array}{c} 1200 \\ V_{CEsat} \\ - \\ \end{array}$	$\begin{array}{c c} V_{GE} = 0 \ V, \ I_C = 500 \ \mu A \\ V_{(BR)CES} \end{array} \begin{array}{c} 1200 \\ - \\ V_{GE} = 15 \ V, \ I_C = 40 \ A \\ V_{GE} = 15 \ V, \ I_C = 40 \ A, \ T_J = 175^{\circ}C \end{array} \begin{array}{c} - \\ 2.40 \end{array}$	$\begin{array}{c c} V_{GE} = 0 \ V, \ I_C = 500 \ \mu A \\ V_{(BR)CES} \end{array} \begin{array}{c} 1200 \\ - \\ - \\ 2.40 \\ - \\ 2.40 \end{array} \begin{array}{c} - \\ - \\ 2.40 \\ - \\ \end{array}$

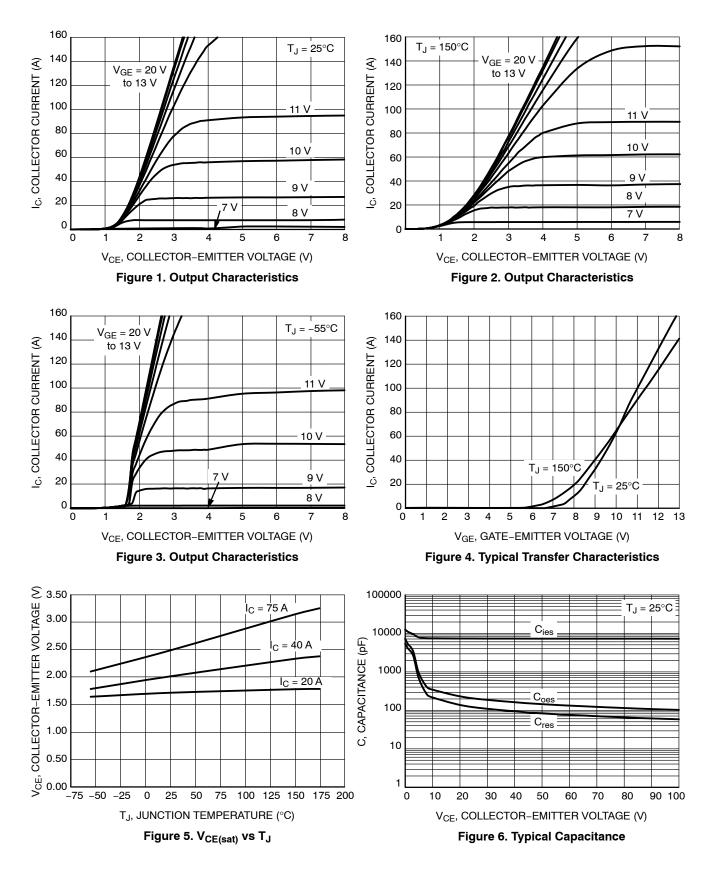
-		Gi = (()				
Collector-emitter cut-off current, gate-	$V_{GE} = 0 V, V_{CE} = 1200 V$	I _{CES}	-	-	0.4	mA
emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 175^{\circ}C$		-	-	2	
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	-	_	200	nA

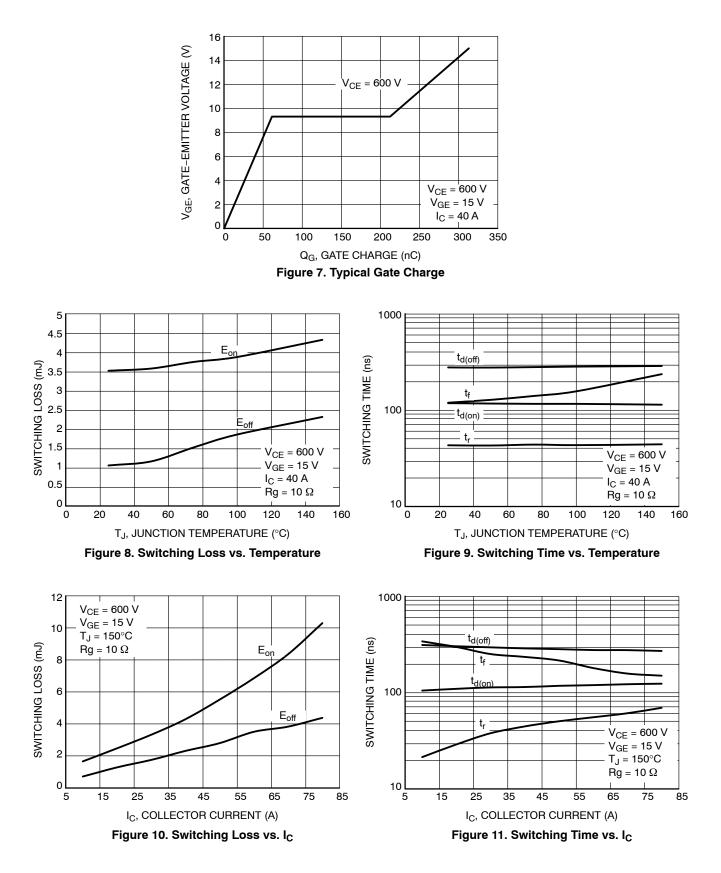
Input capacitance		Cies	-	7385	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	230	-	
Reverse transfer capacitance		C _{res}	-	140	-	
Gate charge total		Qg	-	313	-	nC
Gate to emitter charge	V_{CE} = 600 V, I_C = 40 A, V_{GE} = 15 V	Q _{ge}	-	61	-	
Gate to collector charge		Q _{gc}	-	151	-	

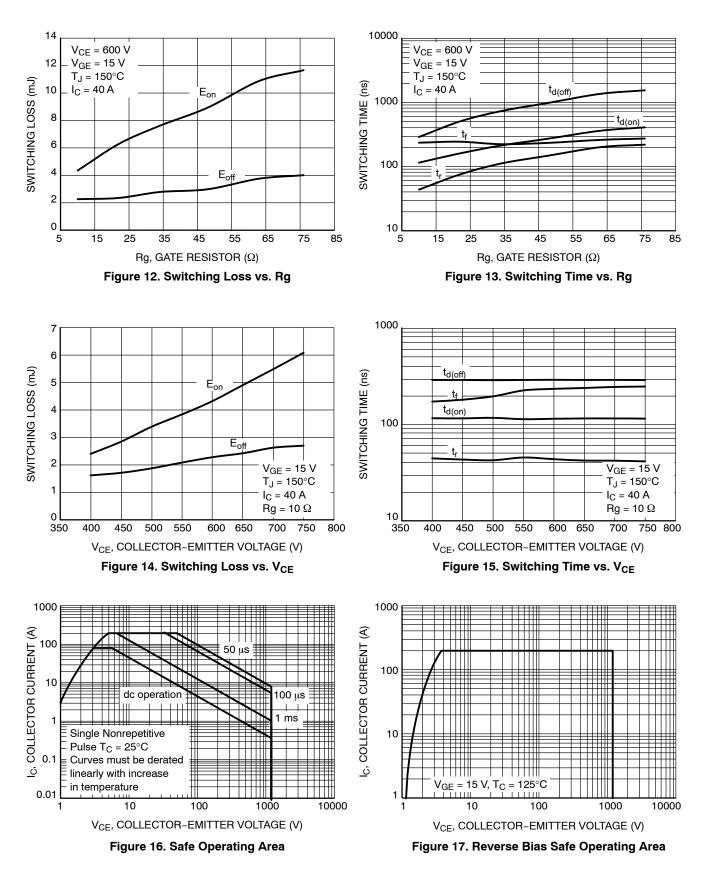
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

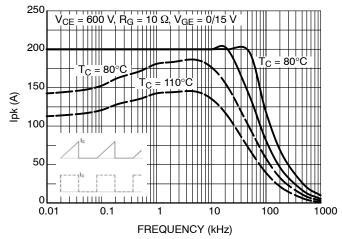
Turn-on delay time		t _{d(on)}	-	116	-	ns
Rise time		t _r	-	42	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	286	-	
Fall time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15\text{ V*}$	t _f	-	121	-	
Turn-on switching loss	V _{GE} = 0 V/ 15V*	E _{on}	-	3.4	-	mJ
Turn-off switching loss		E _{off}	-	1.1	-	
Total switching loss		E _{ts}	-	4.5	-	
Turn-on delay time		t _{d(on)}	-	111	-	ns
Rise time		t _r	-	43	-	
Turn-off delay time	T _J = 175°C V _{CC} = 600 V, I _C = 40 A	t _{d(off)}	-	304	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $B_{c} = 10 \Omega$	t _f	-	260	-	
Turn-on switching loss	$R_{g} = 10 \Omega$ $V_{GE} = 0 V/ 15V*$	E _{on}	-	4.4	-	mJ
Turn-off switching loss		E _{off}	-	2.5	-	1
Total switching loss		E _{ts}	-	6.9	-	1

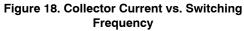
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *Includes diode reverse recovery loss using NGTB40N120FL2WG.











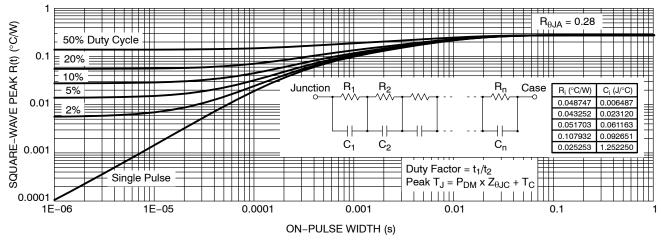


Figure 19. IGBT Transient Thermal Impedance

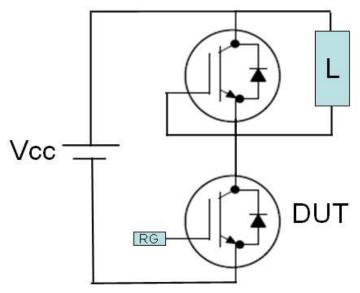


Figure 20. Test Circuit for Switching Characteristics

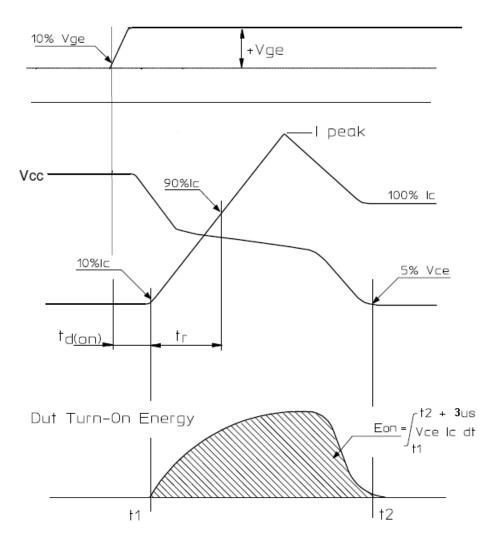


Figure 21. Definition of Turn On Waveform

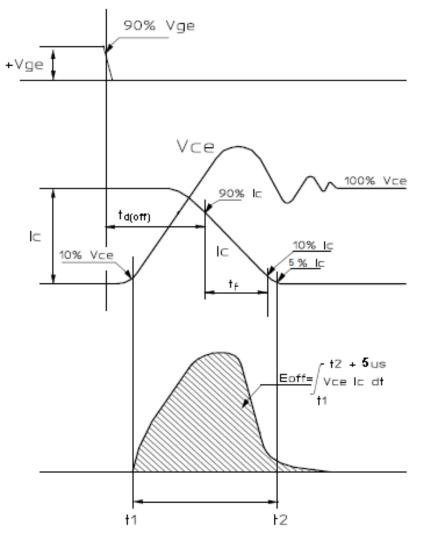
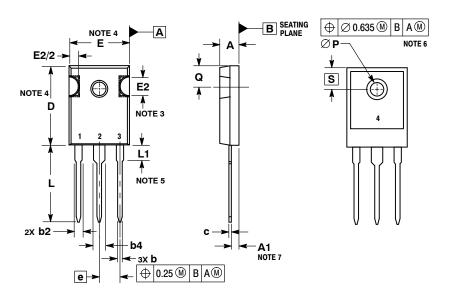


Figure 22. Definition of Turn Off Waveform

PACKAGE DIMENSIONS

TO-247 CASE 340AL **ISSUE A**



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. 2
- SLOT REQUIRED, NOTCH MAY BE ROUNDED. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH.
- 4 MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST
- EXTREME OF THE PLASTIC BODY. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY 5.
- L1. ØP SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE 6 TOP OF THE PART WITH A MAXIMUM DIANET ANGLE OF 1.3 TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED
- 7.

	MILLIMETERS					
DIM	MIN MAX					
Α	4.70	5.30				
A1	2.20	2.60				
b	1.00	1.40				
b2	1.65	2.35				
b4	2.60	3.40				
C	0.40	0.80				
D	20.30	21.40				
E	15.50	16.25				
E2	4.32	5.49				
е	5.45	BSC				
L	19.80	20.80				
L1	3.50	4.50				
Р	3.55	3.65				
Q	5.40	6.20				
S	6.15 BSC					

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